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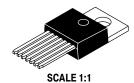
7X b

ØΡ

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⊕ 0.15 M B A M

⊕ 0.14 M B AM



E/2

. Ù

D1 ¥

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TO-220 7-LEAD CASE 821E-04 ISSUE E

B SEATING PLANE

CHAMFER OPTIONAL

Α1

С

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<-A2

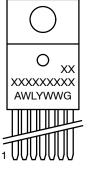
DATE 16 SEP 2009

NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: INCHES.
- CONTROLLING DIMENSION: INCHES.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH AND GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.005 PER SIDE. THESE DIMENSIONS ARE TO BE MEA-SURED AT OUTERMOST EXTREME OF THE PLASTIC BODY.
 DIMENSIONS & DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 0.043.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.140	0.190	3.56	4.83
A1	0.020	0.055	0.51	1.40
A2	0.080	0.115	2.03	2.92
b	0.025	0.040	0.64	1.02
C	0.014	0.026	0.36	0.66
D	0.560	0.625	14.22	15.88
D1	0.320	0.390	8.13	9.91
E	0.380	0.420	9.65	10.67
e	0.050	BSC	1.27 BSC	
L	0.500	0.580	12.70	14.73
Ρ	0.139	0.161	3.53	4.09
U	0.465	0.501	11.81	12.73

GENERIC **MARKING DIAGRAM***



= Assembly Location А

- WL = Wafer Lot
- = Year Y
- WW = Work Week G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

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